

LMR36520AEVM User's Guide

The Texas Instruments LMR36520 EVM evaluation module (EVM) helps designers evaluate the operation and performance of the LMR36520 buck regulator. The LMR36520 is a family of easy-to-use synchronous step-down DC/DC converters capable of driving up to 2 A of load current from an input voltage of 4.2 V to 65 V. The LMR36520 EVM features a selectable output voltage of 3.3 V or 5 V and a switching frequency of 400 kHz. See the *LMR36520 4.2-V to 60-V, 1.5-A Ultra-small Synchronous Step-down Converter Data Sheet* for additional features, detailed description, and available options.

Table 1 shows the EVM options.

EVM	DEVICE	FREQUENCY / OUTPUT CURRENT
LMR36520AEVM	LMR36520ADDAR	400 kHz / 2A

Table 1. Device and Package Configurations



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1 Setup

This section describes the test points and connectors on the EVM and how to properly connect, set up, and use the LMR36520AEVM. Either the banana jacks and test points on the top of the board can be used for connections, or the card edge connector can be used. See Figure 1 for the top of board connections, and Figure 2 for the card edge connections. The following lists the functions of the connections:

- VINEMI Input supply to EVM with an EMI filter. Connect to a suitable input supply. See the LMR36520 4.2-V to 60-V, 1.5-A Ultra-small Synchronous Step-down Converter Data Sheet for input supply requirements.
- **GND** System ground
- **VOUT** Output of EVM. Connect to the desired load.
- **VOS** Output voltage sense connection
- VIS Input voltage sense connection
- GNDS Ground sense point for analog measurements



Figure 1. EVM Board Connections

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Figure 2. EVM Card Edge Connections

1.1 Jumpers

See Figure 3 for jumper locations.

- **EN** This jumper allows the EN input to be connected to either ground (OFF) or VIN (ON). Remove this jumper to allow an external logic signal to control the EN function.
- **VOUT** This jumper is used to select one of the two pre-defined output voltages. The "3.3 V" position provides a 3.3 V output while the "5 V" position provides a 5 V output.



Figure 3. Jumper Locations

1.2 Test Points

- VINEMI Input supply to EVM with an EMI filter. Connect to a suitable input supply. See the LMR36520 4.2-V to 60-V, 1.5-A Ultra-small Synchronous Step-down Converter Data Sheet for input supply requirements.
- GND System power ground
- **VOUT** Power output of EVM. Connect to the desired load.
- **VOS** Output voltage sense connection; connect to DMM. VOS is also used for frequency response analyzer connection.



- GNDS Ground sense point for analog measurements; connect to DMM.
- VCC Test point to measure internal VCC of device; approximately 5 V. On-board PGOOD pullup resistor is connected to VCC.
- EN Connection for external EN logic input. Remove EN jumper and connect controlling logic to EN test point for external enable control.
- **PGOOD** Power-good flag output. This test point is connected to VCC through a 20 k Ω resistor. The power good function can be monitored at this test point.
- A Connection for frequency response analyzer (on bottom of board). See Figure 4.



Figure 4. Frequency Response Analyzer Setup

2 Operation

Once the above connections are made and the appropriate jumpers are set, the EVM is ready for use. If external control of the EN input is desired, remove the EN jumper, and apply the external signal to the EN test point and GND. The PGOOD output is pulled up to VCC through a 20-k Ω resistor. This way, the PGOOD signal swings from 0 V to about 5 V to indicate when the output voltage is either outside or inside of the PGOOD window, respectively. If an external pullup and supply is desired for the PGOOD function, remove the 20-k Ω resistor, and pull the PGOOD test point up to the desired voltage through an appropriate resistance. See the *LMR36520 4.2-V to 60-V, 1.5-A Ultra-small Synchronous Step-down Converter Data Sheet* for more details.

The output voltage of the EVM can be selected by the VOUT jumper to either 3.3 V or 5 V. Other values of output voltage can be programmed by changing the value of R_{FBB} on the EVM. In addition, the values of the inductor and the output capacitance can also need to be changed. See the *LMR36520 4.2-V to 60-V*, *1.5-A Ultra-small Synchronous Step-down Converter Data Sheet* for more information.

Operation



Operation

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The EVM has been designed for maximum flexibility regarding component selection. This allows you to place preferred components, such as the inductor and capacitors, on the board and test the performance of the regulator. This way, the power supply system can be tested before committing the design to production.



Schematic

3 Schematic



Figure 5. LMR36520AEVM Schematic



Board Layout

4 Board Layout



Figure 6. Top View of EVM



Figure 7. EVM Top Copper Layer



Figure 8. EVM Mid-Layer One





Figure 9. EVM Mid-Layer Two



Figure 10. EVM Bottom Copper Layer

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Bill of Materials

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DESIGNATOR	COMMENT	DESCRIPTION	MANUFACTURER	PART NUMBER	QUANTITY
C1	CINB	CAP, AL, 22 μF, 100 V, ±20%, 1.3 Ω, AEC-Q200 Grade 1, SMD	Panasonic	EEETG2A220UP	1
C2, C3, C12, C13	CIN1, CIN2, C12, C13	CAP, CERM, 4.7 μF, 100 V, ±10%, X7S, AEC-Q200 Grade 1, 1210	TDK	CGA6M3X7S2A475K200A B	4
C4	CHF1	CAP, CERM, 0.22 μF, 100 V, ±10%, X7R, 0805	MuRata	GRM21AR72A224KAC5L	1
C5	CVcc	CAP, CERM, 1 µF, 25 V, ±10%, X5R, 0603	TDK	C1608X5R1E105K080AC	1
C6	Cboot	CAP, CERM, 0.1 µF, 25 V, ±10%, X7R, 0603	AVX	06033C104KAT2A	1
C7, C8, C9, C10	CO1, CO2, CO3, CO4	CAP, CERM, 22 μF, 25 V, ±10%, X5R, 1210	Samsung Electro- Mechanics	CL32A226KAJNNNE	4
C11	CFF	CAP, CERM, 10 pF, 50 V, ±5%, C0G/NP0, 0603	MuRata	GRM1885C1H100JA01D	0
FID1, FID2, FID3, FID4, FID5, FID6	Fiducial	Fiducial mark. There is nothing to buy or mount.	N/A	N/A	0
J1, J2, J3	VINEMI, GND, VOUT	Standard Banana Jack, Uninsulated, 8.9 mm	Keystone	575-8	3
J4, J5	EN, VOUT	Header, 100 mil, 3x1, Gold, TH	Samtec	HTSW-103-07-G-S	2
L1	XAL6060-103MEB	Inductor, Shielded, Composite, 10 $\mu H,$ 7 A, 0.02982 $\Omega,$ AEC-Q200 Grade 1, SMD	Coilcraft	XAL6060-103MEB	1
L2	XAL4030-472MEB	Inductor, Shielded, Composite, 4.7 μH, 4.5 A, 0.0401 Ω, SMD	Coilcraft	XAL4030-472MEB	1
L3	FBMH3225HM601N T	Ferrite Bead, 600 Ω at 100 MHz, 3 A, 1210	Taiyo Yuden	FBMH3225HM601NT	1
LBL1	THT-13-457-10		Brady	THT-13-457-10	1
R1	Rinj	RES, 10.0, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	Vishay-Dale	CRCW060310R0FKEA	1
R2	RFBT2	RES, 34.0 k, 1%, 0.1 W, 0603	Yageo	RC0603FR-0734KL	1
R3	RFBT1	RES, 46.4 k, 1%, 0.1 W, 0603	Yageo	RC0603FR-0746K4L	1
R4, R5	RFBB, Rpg	RES, 20.0 k, 1%, 0.1 W, 0603	Yageo	RC0603FR-0720KL	2
R6	RVINS	RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	Vishay-Dale	CRCW06030000Z0EA	1
SH-J1, SH-J2	EN, VOUT	Shunt, 100 mil, Gold-plated, Black	Samtec	SNT-100-BK-G	2
TP1, TP2, TP3, TP4, TP5, TP6	EN, VCC, PGOOD, SW, VOS, VIS	Test Point, Multipurpose, Red, TH	Keystone	5010	6
TP7, TP8, TP9, TP10	GNDS, GNDS, GND, GND	Test Point, Multipurpose, Black, TH	Keystone	5011	4
U1	LMR36520ADDAR	SIMPLE SWITCHER(R) 4.2 V to 65 V Synchronous Step-Down Converter, DDA0008J (HSOIC-8)	Texas Instruments	LMR36520ADDAR	1

Table 2. BOM for LMR36520AEVM

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